ABSTRACT

There is disclosed a photosensitive resin composition for interlayer insulating films, surface protection films or the like, which exhibits excellent resolution and can be developed with an aqueous alkaline solution. The photosensitive resin composition is prepared using a polymer at least having a constitutional repeating unit represented by general formula II:

$$R^{5}$$
 R^{5}
 R^{2}
 R^{4}
 R^{3}
 R^{9}
 R^{6}
 R^{7}
 R^{7}

5

wherein R¹ represents hydrogen atom or methyl group; R² to R9 independently represent hydrogen atom, halogen atom or alkyl group having 10 1 to 4 carbon atoms; X represents -CH=N-, -CONH-, -(CH₂)_n-CH=N- or -(CH₂)_n-CONH- and the N atom in X is bonded to a carbon atom in the benzene ring having AO- at an o-position; A represents hydrogen atom or a group being decomposed by an acid; and n represents a positive integer of 1 to 3.